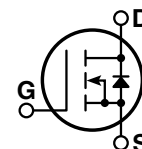


POWER MOS 7® MOSFET

Power MOS 7® is a new generation of low loss, high voltage, N-Channel enhancement mode power MOSFETS. Both conduction and switching losses are addressed with Power MOS 7® by significantly lowering $R_{DS(ON)}$ and Q_g . Power MOS 7® combines lower conduction and switching losses along with exceptionally fast switching speeds inherent with APT's patented metal gate structure.



- Lower Input Capacitance
- Lower Miller Capacitance
- Lower Gate Charge, Q_g
- Increased Power Dissipation
- Easier To Drive
- Popular SOT-227 Package



MAXIMUM RATINGS

All Ratings: $T_C = 25^\circ\text{C}$ unless otherwise specified.

Symbol	Parameter	APT20M20JLL	UNIT
V_{DSS}	Drain-Source Voltage	200	Volts
I_D	Continuous Drain Current @ $T_C = 25^\circ\text{C}$	104	Amps
I_{DM}	Pulsed Drain Current ①	416	
V_{GS}	Gate-Source Voltage Continuous	± 30	Volts
V_{GSM}	Gate-Source Voltage Transient	± 40	
P_D	Total Power Dissipation @ $T_C = 25^\circ\text{C}$	463	Watts
	Linear Derating Factor	3.70	W/ $^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to 150	$^\circ\text{C}$
T_L	Lead Temperature: 0.063" from Case for 10 Sec.	300	
I_{AR}	Avalanche Current ① (Repetitive and Non-Repetitive)	100	Amps
E_{AR}	Repetitive Avalanche Energy ①	50	mJ
E_{AS}	Single Pulse Avalanche Energy ④	2500	

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
BV_{DSS}	Drain-Source Breakdown Voltage ($V_{GS} = 0V, I_D = 250\mu A$)	200			Volts
$R_{DS(on)}$	Drain-Source On-State Resistance ② ($V_{GS} = 10V, I_D = 52A$)			0.020	Ohms
I_{DSS}	Zero Gate Voltage Drain Current ($V_{DS} = 200V, V_{GS} = 0V$)			100	μA
	Zero Gate Voltage Drain Current ($V_{DS} = 160V, V_{GS} = 0V, T_C = 125^\circ\text{C}$)			500	
I_{GSS}	Gate-Source Leakage Current ($V_{GS} = \pm 30V, V_{DS} = 0V$)			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage ($V_{DS} = V_{GS}, I_D = 2.5mA$)	3		5	Volts



CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

DYNAMIC CHARACTERISTICS

APT20M20JLL

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C_{iss}	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1\text{ MHz}$		6850		pF
C_{oss}	Output Capacitance			2180		
C_{rss}	Reverse Transfer Capacitance			95		
Q_g	Total Gate Charge ③	$V_{GS} = 10V$ $V_{DD} = 100V$ $I_D = 104A @ 25^\circ C$		110		nC
Q_{gs}	Gate-Source Charge			43		
Q_{gd}	Gate-Drain ("Miller") Charge			47		
$t_{d(on)}$	Turn-on Delay Time	RESISTIVE SWITCHING $V_{GS} = 15V$ $V_{DD} = 100V$ $I_D = 104A @ 25^\circ C$ $R_G = 0.6\Omega$		13		ns
t_r	Rise Time			40		
$t_{d(off)}$	Turn-off Delay Time			26		
t_f	Fall Time			2		
E_{on}	Turn-on Switching Energy ⑥	INDUCTIVE SWITCHING @ 25°C $V_{DD} = 130V, V_{GS} = 15V$ $I_D = 104A, R_G = 5\Omega$		465		μJ
E_{off}	Turn-off Switching Energy			455		
E_{on}	Turn-on Switching Energy ⑥	INDUCTIVE SWITCHING @ 125°C $V_{DD} = 130V, V_{GS} = 15V$ $I_D = 104A, R_G = 5\Omega$		920		
E_{off}	Turn-off Switching Energy			915		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
I_S	Continuous Source Current (Body Diode)			104	Amps
I_{SM}	Pulsed Source Current ① (Body Diode)			416	
V_{SD}	Diode Forward Voltage ② ($V_{GS} = 0V, I_S = -I_D 104A$)			1.3	Volts
t_{rr}	Reverse Recovery Time ($I_S = -I_D 104A, di_S/dt = 100A/\mu s$)		284		ns
Q_{rr}	Reverse Recovery Charge ($I_S = -I_D 104A, di_S/dt = 100A/\mu s$)		3.06		μC
dv/dt	Peak Diode Recovery dv/dt ⑤			5	V/ns

THERMAL CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to Case			0.27	$^\circ C/W$
$R_{\theta JA}$	Junction to Ambient			40	

① Repetitive Rating: Pulse width limited by maximum junction temperature

② Pulse Test: Pulse width < 380 μs , Duty Cycle < 2%

③ See MIL-STD-750 Method 3471

④ Starting $T_J = +25^\circ C$, $L = 0.46mH$, $R_G = 25\Omega$, Peak $I_L = 104A$

⑤ dv/dt numbers reflect the limitations of the test circuit rather than the device itself. $I_S \leq -I_D 75A$ $di/dt \leq 700A/\mu s$ $V_R \leq V_{DSS}$ $T_J \leq 150^\circ C$

⑥ E_{on} includes diode reverse recovery. See figures 18, 20.

APT Reserves the right to change, without notice, the specifications and information contained herein.

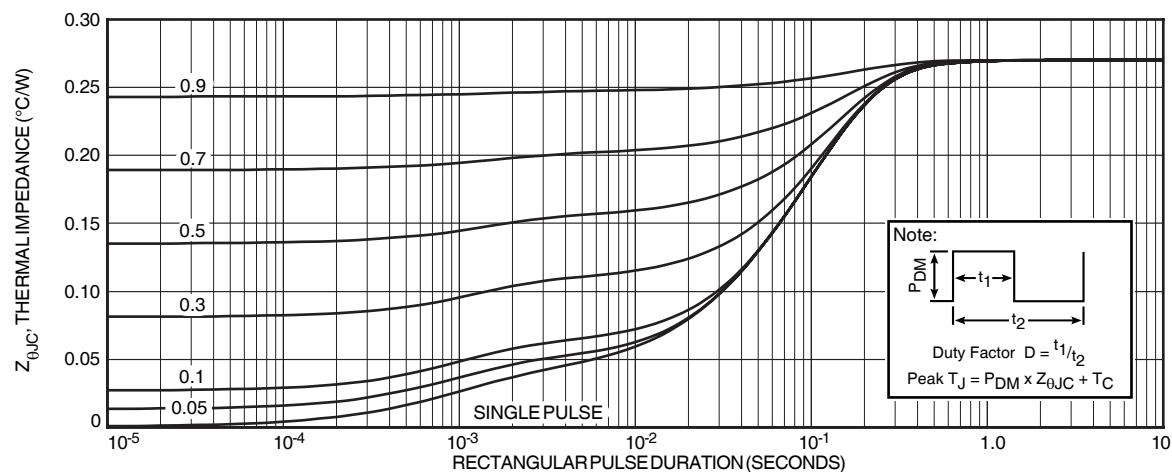


FIGURE 1, MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs PULSE DURATION

Typical Performance Curves

APT20M20JLL

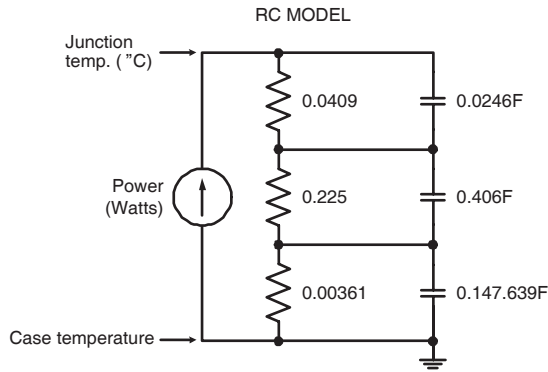


FIGURE2, TRANSIENT THERMAL IMPEDANCE MODEL

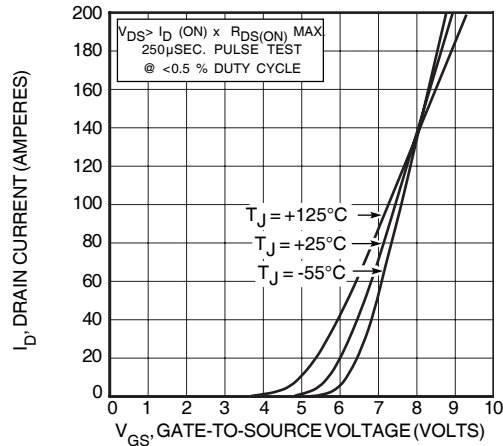


FIGURE4, TRANSFER CHARACTERISTICS

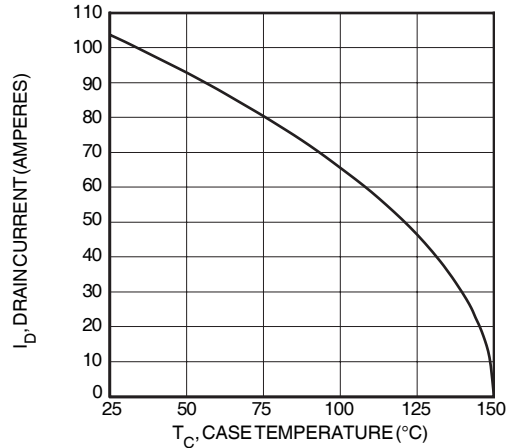


FIGURE6, MAXIMUM DRAIN CURRENT vs CASE TEMPERATURE

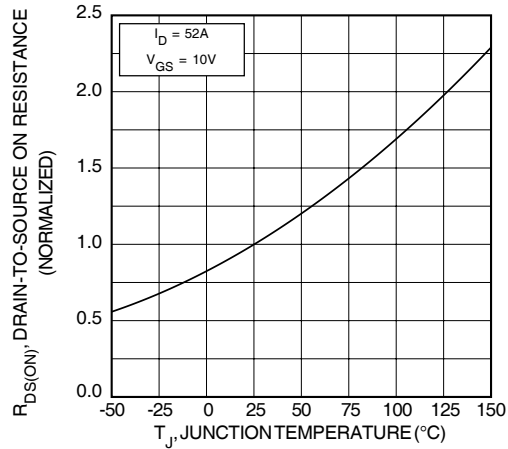


FIGURE8, $R_{DS(ON)}$ vs. TEMPERATURE

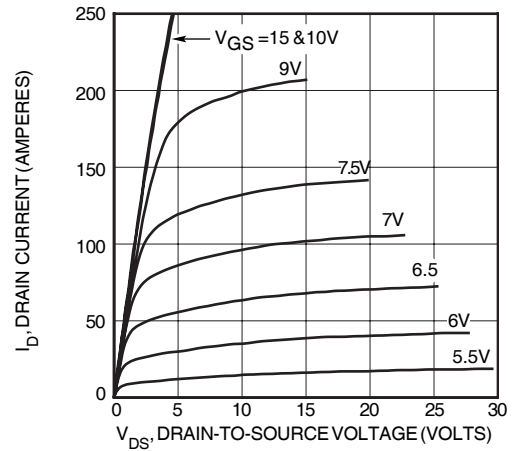


FIGURE3, LOW VOLTAGE OUTPUT CHARACTERISTICS

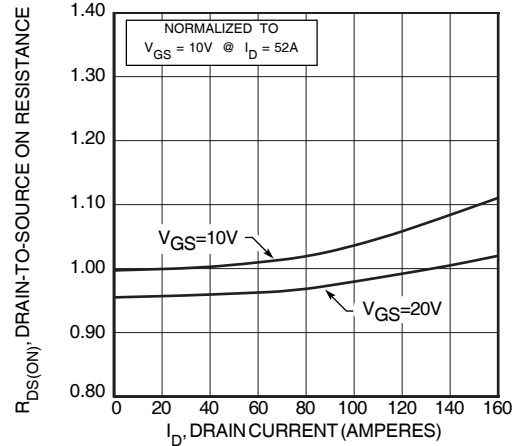


FIGURE5, $R_{DS(ON)}$ vs DRAIN CURRENT

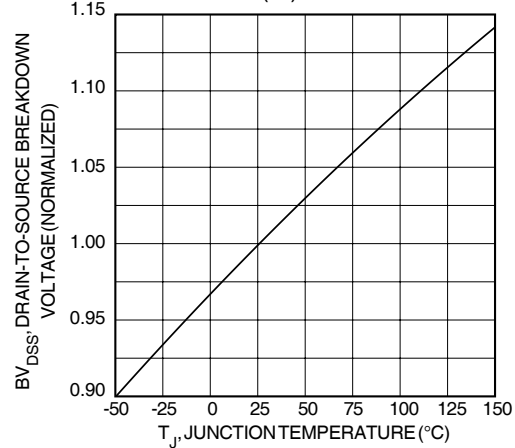


FIGURE7, BREAKDOWN VOLTAGE vs TEMPERATURE

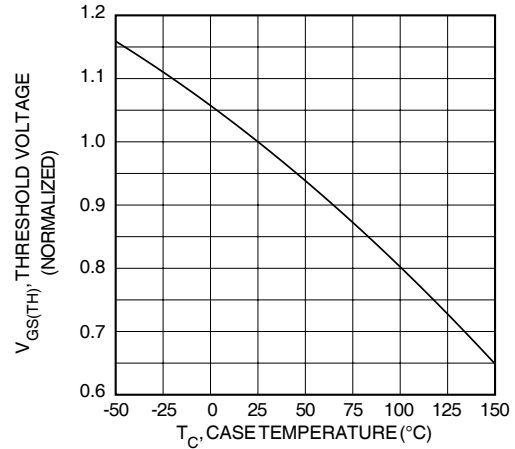


FIGURE9, THRESHOLD VOLTAGE vs TEMPERATURE

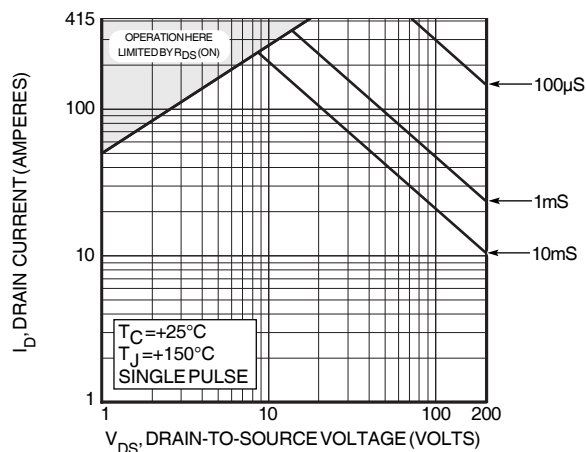


FIGURE 10, MAXIMUM SAFE OPERATING AREA

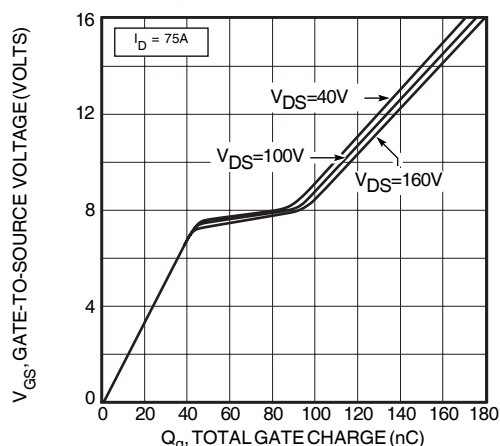


FIGURE 12, GATE CHARGE vs GATE-TO-SOURCE VOLTAGE

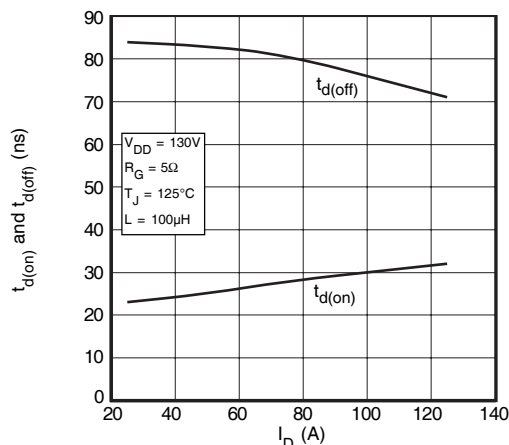


FIGURE 14, DELAY TIMES vs CURRENT

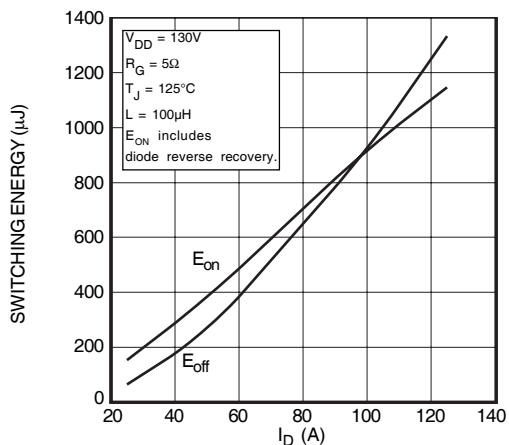


FIGURE 16, SWITCHING ENERGY vs CURRENT

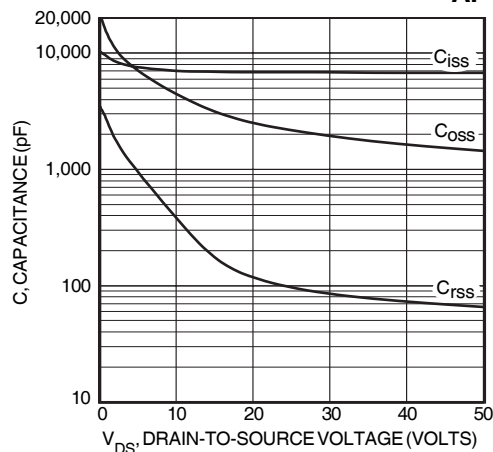


FIGURE 11, CAPACITANCE vs DRAIN-TO-SOURCE VOLTAGE

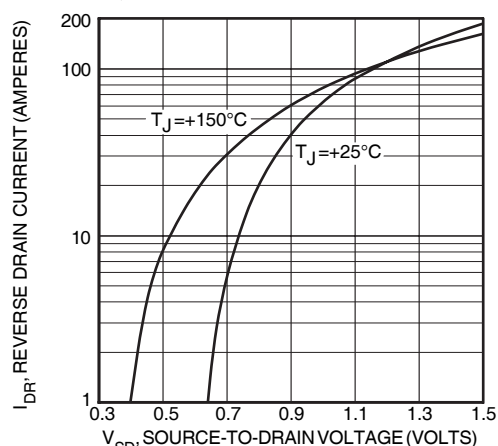


FIGURE 13, SOURCE-DRAIN DIODE FORWARD VOLTAGE

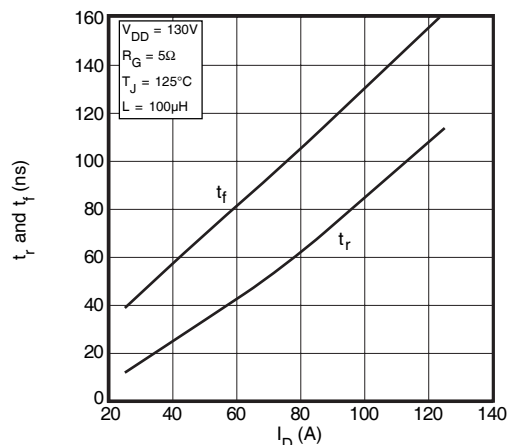


FIGURE 15, RISE AND FALL TIMES vs CURRENT

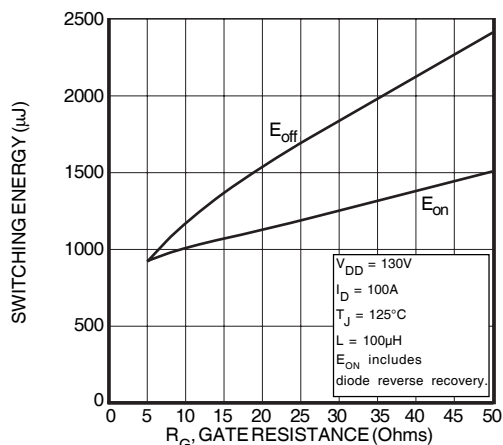
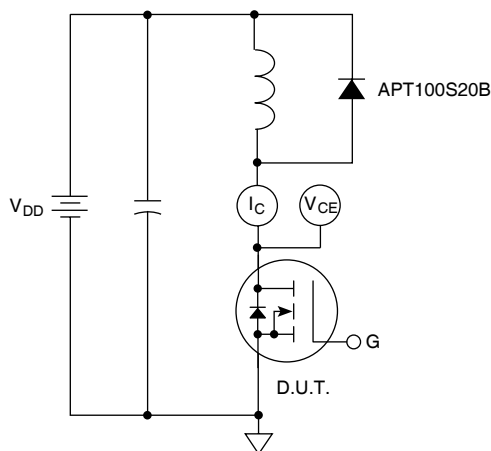
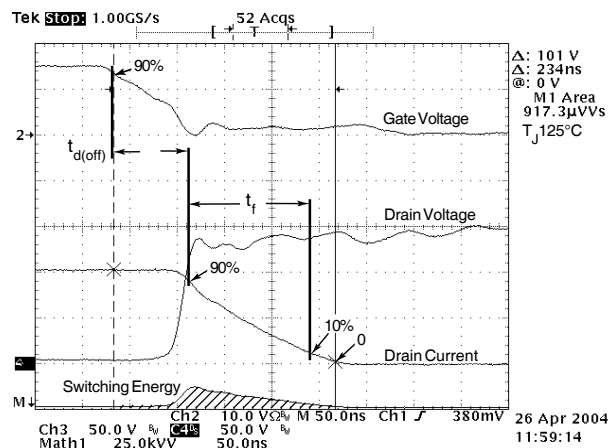
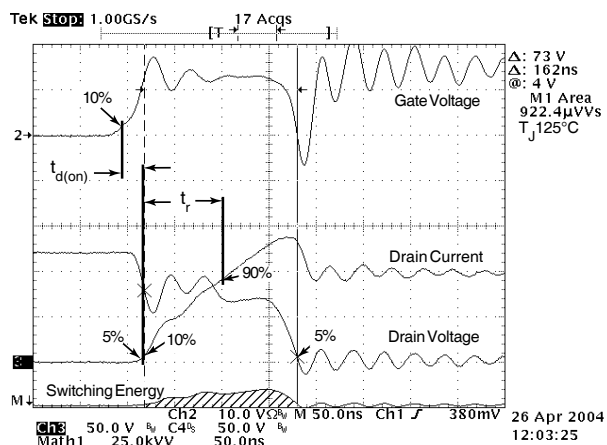


FIGURE 17, SWITCHING ENERGY vs. GATE RESISTANCE



Technical drawing of the 2N4350 MOSFET package, showing dimensions in millimeters (mm) and inches (in).

Top View Dimensions:

- Overall width: 31.5 (1.240) mm, 31.7 (1.248) mm
- Pin pitch (center-to-center): 7.8 (.307) mm, 8.2 (.322) mm
- Pin diameter: $r = 4.0 (.157)$ mm (2 places)
- Pin width: 4.0 (.157) mm, 4.2 (.165) mm (2 places)
- Pin spacing (inner): 3.3 (.129) mm, 3.6 (.143) mm
- Pin width (inner): 14.9 (.587) mm, 15.1 (.594) mm
- Pin spacing (outer): 30.1 (1.185) mm, 30.3 (1.193) mm
- Pin width (outer): 38.0 (1.496) mm, 38.2 (1.504) mm

Side View Dimensions:

- Overall height: 11.8 (.463) mm, 12.2 (.480) mm
- Pin height: 8.9 (.350) mm, 9.6 (.378) mm
- Pin diameter: 4.0 (.157) mm, 4.2 (.165) mm (2 places)
- Pin spacing (inner): 3.3 (.129) mm, 3.6 (.143) mm
- Pin width (inner): 14.9 (.587) mm, 15.1 (.594) mm
- Pin spacing (outer): 30.1 (1.185) mm, 30.3 (1.193) mm
- Pin width (outer): 38.0 (1.496) mm, 38.2 (1.504) mm

Detail View Dimensions:

- Pin diameter: 4.0 (.157) mm, 4.2 (.165) mm (2 places)
- Pin spacing (inner): 3.3 (.129) mm, 3.6 (.143) mm
- Pin width (inner): 14.9 (.587) mm, 15.1 (.594) mm
- Pin spacing (outer): 30.1 (1.185) mm, 30.3 (1.193) mm
- Pin width (outer): 38.0 (1.496) mm, 38.2 (1.504) mm

Notes:

- * Source
- Drain
- * Source
- Gate
- * Source terminals are shorted internally. Current handling capability is equal for either Source terminal.

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